L Number	Hits	Search Text	DB	Time stamp
-	2	("6664621").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:43
-	66060	microelectronic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:43
-	543	microelectronic and interconnect and (active same microelectronic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:44
-	352	(microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:44
-	23	((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:49
-	22	(((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable))) and (copper or cu or gold or au or ag or silver)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:50
-	8	((((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:50
-	63	((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:49
-	60	(((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 12:50
-	27	((((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 13:03
-	20	(((((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))) and (438/$.ccls. or 257/$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 13:05

| - | | 14 | (((((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))) and (438/$.ccls. or 257/$.ccls.)) and pad and (bond$3 near10 (pressure or force)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/16 13:05 |
| - | | 14 | (((((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))) and (438/$.ccls. or 257/$.ccls.)) and pad and (bond$3 near10 (pressure or force))) and bump | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/16 13:06 |